Standard MOSFETs nomenclature

Device type
- **F** = MOSFET

Process designator
- **No suffix** = Gen 3
- **5** = Gen 5
- **7** = Gen 7

Package type
- **No suffix** = TO-204AA, AF
- **C** = chip
- **E** = LCC-18
- **F** = TO-205AF
- **G** = MO-036AB
- **M** = TO-254AA
- **MJ** = D3
- **MS** = Low ohmic TO-254AA
- **N** = SMD-1
- **NA** = SMD-2
- **NB** = SMD-3
- **NJ** = SMD-0.5
- **Q** = LCC-28
- **V** = TO-258AA
- **Y** = TO-257AA
- **YJ** = D2
- **YS** = Low ohmic TO-257AA

Voltage rating/Die size/
Channel designator

Lead option
- **A** = Lead form down*
- **B** = Lead form up
- **C** = Lead trimmed (clipped)
- **D** = Carrier (applies only to SMD-1 and SMD-2)
  *Lead attach if package is SMD

Screening level
- **SCX** = TX level
- **SCV** = TXV level
- **SCS** = Space level

Pin out designator
- Applies only to TO-257M
- **No suffix**
  - **1** = Gate
  - **2** = Drain
  - **3** = Source
- **M**
  - **1** = Drain
  - **2** = Source
  - **3** = Gate

Eyelet designator
- Applies only to TO-257AA
- **No suffix** = Glass
- **C** = Ceramic